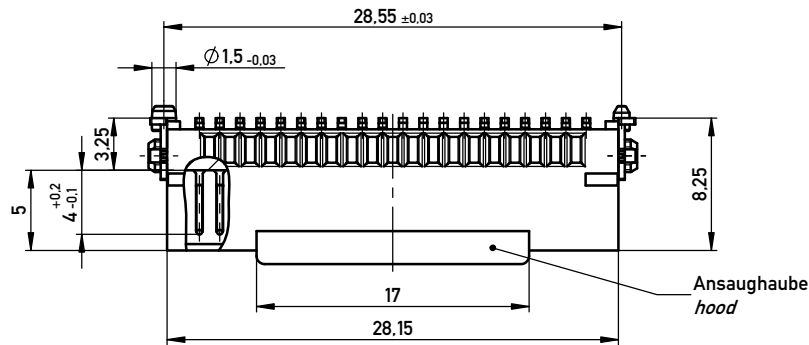
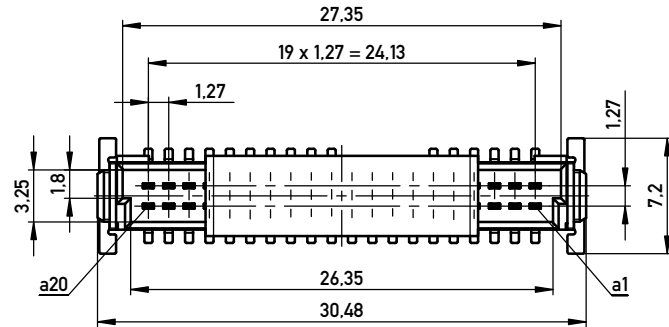
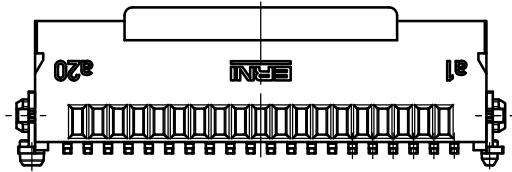
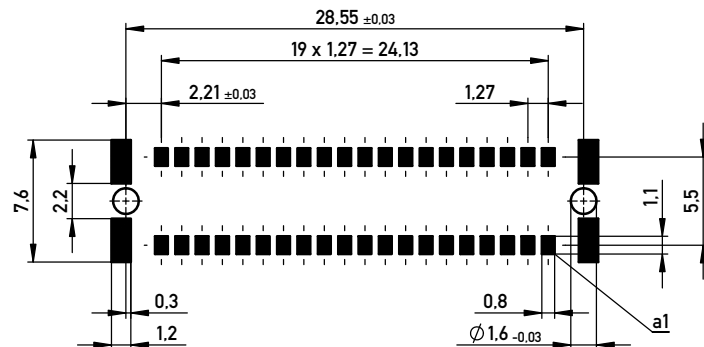




Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT



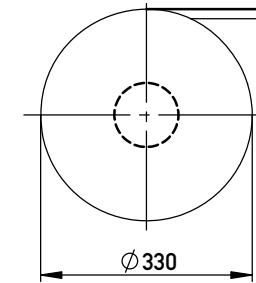
Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

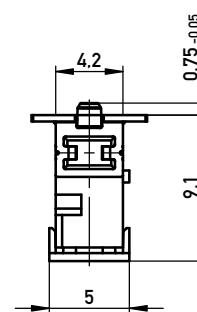
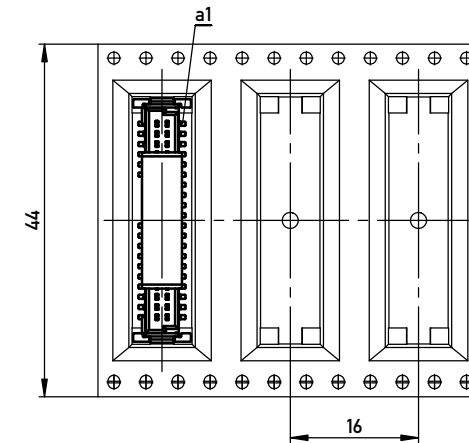
Anschlussbereich verzinkt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0.1 mm
Coplanarity Area of Termination ≤ 0.1 mm

Verpackt im Gurt nach DIN IEC 60286-3
Tape on Reel Packaging according to DIN IEC 60286-3
Verpackungseinheit: 280 Stück
Packaging unit: 280 pcs



Abspulrichtung - Reel off Direction



BA 8-03 - Standard Bauhöhe

type 8-03 - Standard Assembly Height

Information:				Tolerances		 All Dimensions in mm		Scale 3:1	
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						Messerl. SMC-Q 40-SMD-BA8-03 <i>Male SMD-Q 40-SMD-type8-03</i>			
						254539			
e		26.06.2015				www.ERNI.com		I	
Index		Date						A3	

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